

IN74AC138

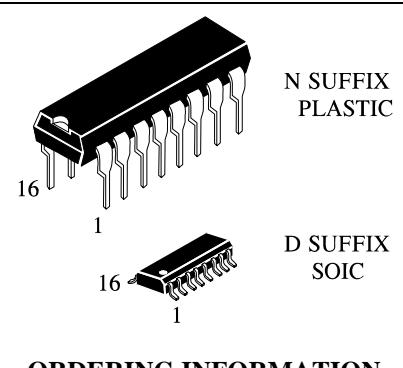
1-of-8 Decoder/Demultiplexer

High-Speed Silicon-Gate CMOS

The IN74AC138 is identical in pinout to the LS/ALS138, HC/HCT138. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LS/ALS outputs.

The IN74AC138 decodes a three-bit Address to one-of-eight active-low outputs. This device features three Chip Select inputs, two active-low and one active-high to facilitate the demultiplexing, cascading, and chip-selecting functions. The demultiplexing function is accomplished by using the Address inputs to select the desired device output; one of the Chip Selects is used as a data input while the other Chip Selects are held in their active states.

- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1.0 μ A; 0.1 μ A @ 25°C
- High Noise Immunity Characteristic of CMOS Devices
- Outputs Source/Sink 24 mA

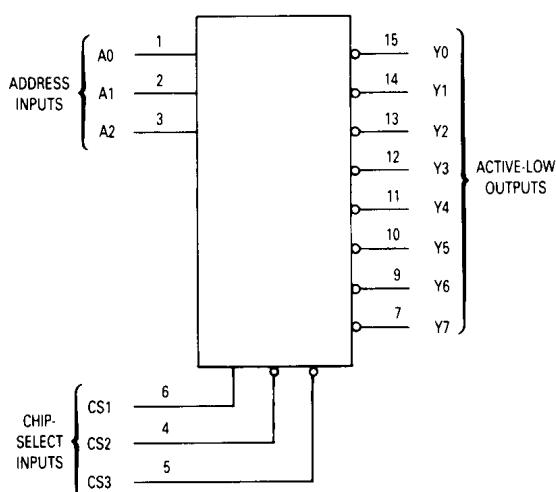
**ORDERING INFORMATION**

IN74AC138N Plastic
IN74AC138D SOIC

$T_A = -40^\circ$ to 85° C for all packages

PIN ASSIGNMENT

| | | | |
|-----|-----|----|-----------------|
| A0 | 1 ● | 16 | V _{CC} |
| A1 | 2 | 15 | Y ₀ |
| A2 | 3 | 14 | Y ₁ |
| CS2 | 4 | 13 | Y ₂ |
| CS3 | 5 | 12 | Y ₃ |
| CS1 | 6 | 11 | Y ₄ |
| Y7 | 7 | 10 | Y ₅ |
| GND | 8 | 9 | Y ₆ |

LOGIC DIAGRAM

PIN 16 = V_{CC}
PIN 8 = GND

FUNCTION TABLE

| Inputs | | | Outputs | | | | | | | | | | |
|--------|-----|-----|---------|----|----|----|----|----|----|----|----|----|----|
| CS1 | CS2 | CS3 | A2 | A1 | A0 | Y0 | Y1 | Y2 | Y3 | Y4 | Y5 | Y6 | Y7 |
| X | X | H | X | X | X | H | H | H | H | H | H | H | H |
| X | H | X | X | X | X | H | H | H | H | H | H | H | H |
| L | X | X | X | X | X | H | H | H | H | H | H | H | H |
| H | L | L | L | L | L | L | H | H | H | H | H | H | H |
| H | L | L | L | L | H | H | L | H | H | H | H | H | H |
| H | L | L | L | H | H | H | H | L | H | H | H | H | H |
| H | L | L | L | H | H | H | H | H | L | H | H | H | H |
| H | L | L | H | L | L | H | H | H | H | L | H | H | H |
| H | L | L | H | L | H | H | H | H | H | H | L | H | H |
| H | L | L | H | H | L | H | H | H | H | H | H | L | H |
| H | L | L | H | H | H | H | H | H | H | H | H | H | L |

H = high level (steady state)

L = low level (steady state)

X = don't care

MAXIMUM RATINGS*

| Symbol | Parameter | Value | Unit |
|------------------|---|------------------------------|------|
| V _{CC} | DC Supply Voltage (Referenced to GND) | -0.5 to +7.0 | V |
| V _{IN} | DC Input Voltage (Referenced to GND) | -0.5 to V _{CC} +0.5 | V |
| V _{OUT} | DC Output Voltage (Referenced to GND) | -0.5 to V _{CC} +0.5 | V |
| I _{IN} | DC Input Current, per Pin | ±20 | mA |
| I _{OUT} | DC Output Sink/Source Current, per Pin | ±50 | mA |
| I _{CC} | DC Supply Current, V _{CC} and GND Pins | ±50 | mA |
| P _D | Power Dissipation in Still Air, Plastic DIP+ SOIC Package+ | 750 500 | mW |
| T _{tsg} | Storage Temperature | -65 to +150 | °C |
| T _L | Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package) | 260 | °C |

*Maximum Ratings are those values beyond which damage to the device may occur.

Functional operation should be restricted to the Recommended Operating Conditions.

+Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C

SOIC Package: : - 7 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter | Min | Max | Unit | |
|------------------------------------|---|--|-----------------|-----------------|------|
| V _{CC} | DC Supply Voltage (Referenced to GND) | 2.0 | 6.0 | V | |
| V _{IN} , V _{OUT} | DC Input Voltage, Output Voltage (Referenced to GND) | 0 | V _{CC} | V | |
| T _J | Junction Temperature (PDIP) | | 140 | °C | |
| T _A | Operating Temperature, All Package Types | -40 | +85 | °C | |
| I _{OH} | Output Current - High | | -24 | mA | |
| I _{OL} | Output Current - Low | | 24 | mA | |
| t _r , t _f | Input Rise and Fall Time * (except Schmitt Inputs) | V _{CC} =3.0 V V _{CC} =4.5 V V _{CC} =5.5 V | 0 0 0 | 150 40 25 | ns/V |

* V_{IN} from 30% to 70% V_{CC}

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range GND≤(V_{IN} or V_{OUT})≤V_{CC}.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol | Parameter | Test Conditions | V _{CC} V | Guaranteed Limits | | Unit |
|------------------|--|---|----------------------|----------------------|----------------------|------|
| | | | | 25 °C | -40°C to 85°C | |
| V _{IH} | Minimum High-Level Input Voltage | V _{OUT} =0.1 V or V _{CC} -0.1 V | 3.0 4.5 5.5 | 2.1 3.15 3.85 | 2.1 3.15 3.85 | V |
| V _{IL} | Maximum Low - Level Input Voltage | V _{OUT} =0.1 V or V _{CC} -0.1 V | 3.0 4.5 5.5 | 0.9 1.35 1.65 | 0.9 1.35 1.65 | V |
| V _{OH} | Minimum High-Level Output Voltage | I _{OUT} ≤ -50 μA | 3.0 4.5 5.5 | 2.9 4.4 5.4 | 2.9 4.4 5.4 | V |
| | | *V _{IN} =V _{IH} or V _{IL} I _{OH} =-12 mA I _{OH} =-24 mA I _{OH} =-24 mA | 3.0 4.5 5.5 | 2.56 3.86 4.86 | 2.46 3.76 4.76 | |
| V _{OL} | Maximum Low-Level Output Voltage | I _{OUT} ≤ 50 μA | 3.0 4.5 5.5 | 0.1 0.1 0.1 | 0.1 0.1 0.1 | V |
| | | *V _{IN} = V _{IH} or V _{IL} I _{OL} =12 mA I _{OL} =24 mA I _{OL} =24 mA | 3.0 4.5 5.5 | 0.36 0.36 0.36 | 0.44 0.44 0.44 | |
| I _{IN} | Maximum Input Leakage Current | V _{IN} =V _{CC} or GND | 5.5 | ±0.1 | ±1.0 | μA |
| I _{OLD} | +Minimum Dynamic Output Current | V _{OLD} =1.65 V Max | 5.5 | | 75 | mA |
| I _{OHD} | +Minimum Dynamic Output Current | V _{OHD} =3.85 V Min | 5.5 | | -75 | mA |
| I _{CC} | Maximum Quiescent Supply Current (per Package) | V _{IN} =V _{CC} or GND | 5.5 | 8.0 | 80 | μA |

* All outputs loaded; thresholds on input associated with output under test.

+Maximum test duration 2.0 ms, one output loaded at a time.

Note: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}

AC ELECTRICAL CHARACTERISTICS ($C_L=50\text{pF}$, Input $t_r=t_f=3.0\text{ ns}$)

| Symbol | Parameter | V_{CC}^* V | Guaranteed Limits | | | | Unit | |
|-----------|--|-----------------|-------------------|--------------|------------------|--------------|------|--|
| | | | 25 °C | | -40°C to 85°C | | | |
| | | | Min | Max | Min | Max | | |
| t_{PLH} | Propagation Delay, Input A to Output Y (Figure 1) | 3.3 5.0 | 1.5 1.5 | 13.0 9.5 | 1.5 1.5 | 15.0 10.5 | ns | |
| t_{PHL} | Propagation Delay, Input A to Output Y (Figure 1) | 3.3 5.0 | 1.5 1.5 | 12.5 9.0 | 1.5 1.5 | 14.0 10.5 | ns | |
| t_{PLH} | Propagation Delay, CS2 or CS3 to Output Y (Figure 3) | 3.3 5.0 | 1.5 1.5 | 15.0 11.0 | 1.5 1.5 | 16.0 12.0 | ns | |
| t_{PHL} | Propagation Delay, CS2 or CS3 to Output Y (Figure 3) | 3.3 5.0 | 1.5 1.5 | 13.5 9.5 | 1.5 1.5 | 15.0 10.5 | ns | |
| t_{PLH} | Propagation Delay, CS1 to Output Y (Figure 2) | 3.3 5.0 | 1.5 1.5 | 15.5 11.0 | 1.5 1.5 | 16.5 12.5 | ns | |
| t_{PHL} | Propagation Delay, CS1 to Output Y (Figure 2) | 3.3 5.0 | 1.5 1.5 | 13.0 8.0 | 1.5 1.0 | 14.0 9.5 | ns | |
| C_{IN} | Maximum Input Capacitance | 5.0 | 4.5 | 4.5 | 4.5 | 4.5 | pF | |

| C_{PD} | Power Dissipation Capacitance | Typical @25°C, $V_{CC}=5.0\text{ V}$ | | pF |
|----------|-------------------------------|--------------------------------------|--|----|
| | | 60 | | |

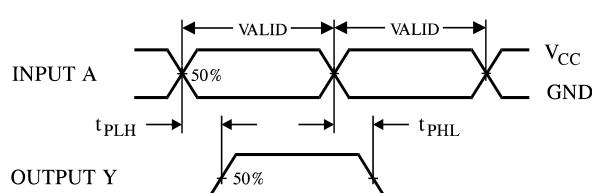
*Voltage Range 3.3 V is $3.3\text{ V} \pm 0.3\text{ V}$ Voltage Range 5.0 V is $5.0\text{ V} \pm 0.5\text{ V}$ 

Figure 1. Switching Waveforms

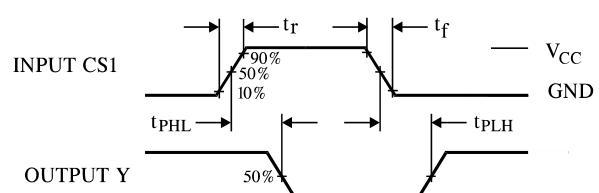


Figure 2. Switching Waveforms

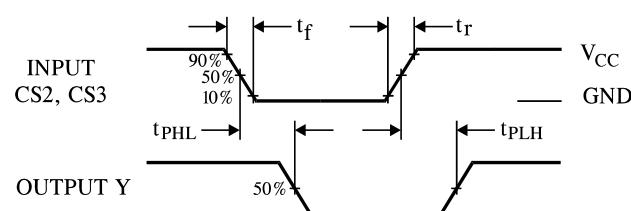
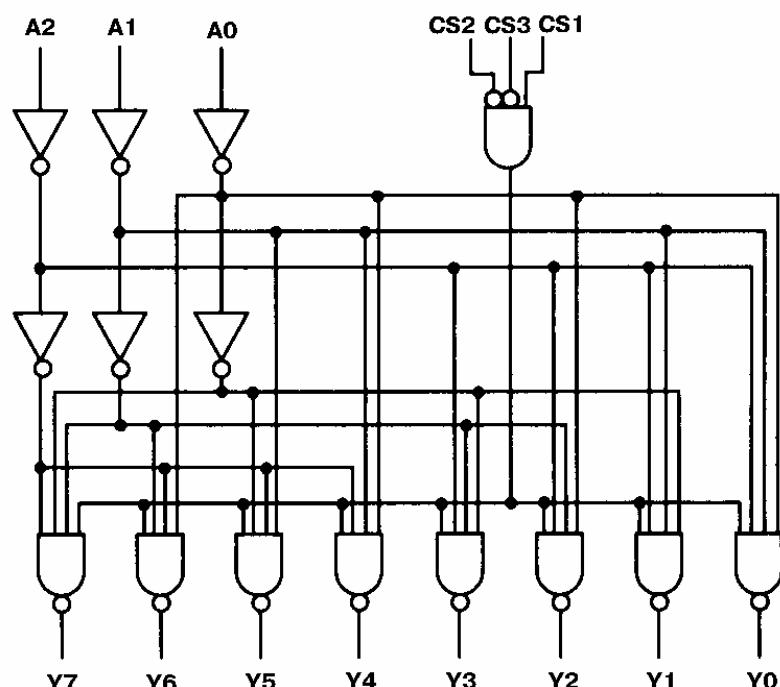
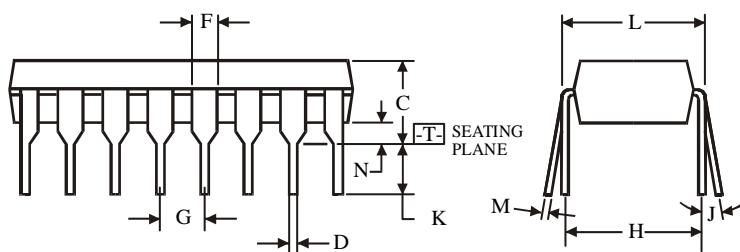
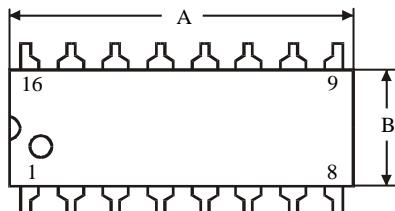


Figure 3. Switching Waveforms

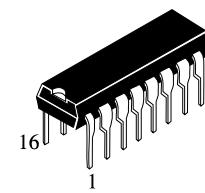
EXPANDED LOGIC DIAGRAM



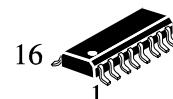
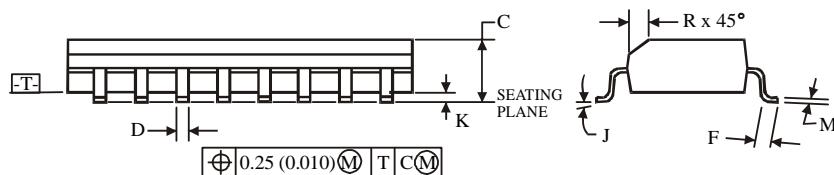
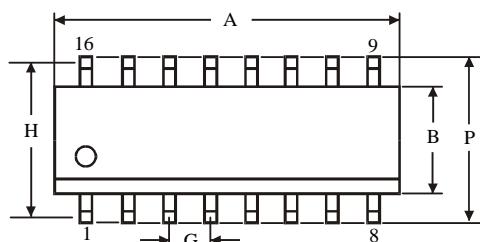
**N SUFFIX PLASTIC DIP
(MS - 001BB)**
**NOTES:**

- Dimensions "A", "B" do not include mold flash or protrusions.

Maximum mold flash or protrusions 0.25 mm (0.010) per side.



| Symbol | Dimension, mm | |
|--------|---------------|------------|
| | MIN | MAX |
| A | 18.67 | 19.69 |
| B | 6.1 | 7.11 |
| C | | 5.33 |
| D | 0.36 | 0.56 |
| F | 1.14 | 1.78 |
| G | | 2.54 |
| H | | 7.62 |
| J | 0° | 10° |
| K | 2.92 | 3.81 |
| L | 7.62 | 8.26 |
| M | 0.2 | 0.36 |
| N | 0.38 | |

**D SUFFIX SOIC
(MS - 012AC)**


| Symbol | Dimension, mm | |
|--------|---------------|-----------|
| | MIN | MAX |
| A | 9.8 | 10 |
| B | 3.8 | 4 |
| C | 1.35 | 1.75 |
| D | 0.33 | 0.51 |
| F | 0.4 | 1.27 |
| G | | 1.27 |
| H | | 5.72 |
| J | 0° | 8° |
| K | 0.1 | 0.25 |
| M | 0.19 | 0.25 |
| P | 5.8 | 6.2 |
| R | 0.25 | 0.5 |

NOTES:

- Dimensions A and B do not include mold flash or protrusion.
- Maximum mold flash or protrusion 0.15 mm (0.006) per side for A; for B - 0.25 mm (0.010) per side.